

AMENDMENT TO THE SPECIFICATION

Please replace the paragraph beginning on page 3, line 15 with the following:

Referring now to FIG. 1, there is shown a schematic diagram of an IC manufacturing equipment 150 that may benefit from embodiments of the present invention. Other IC manufacturing equipments that may also employ embodiments of the present invention are disclosed in co-pending and commonly assigned US Application 09/823,721, now U.S. Patent No. 6,436,843, filed on March 30, 2001, by Henner Meinhold, Fred J. Chetcuti, and Judy Huang. The just mentioned US Application is incorporated herein by reference in its entirety.